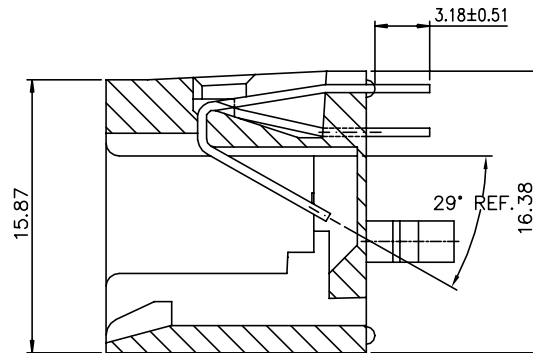
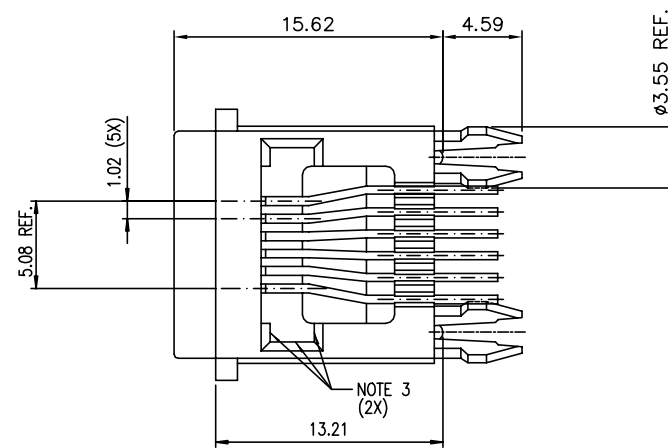
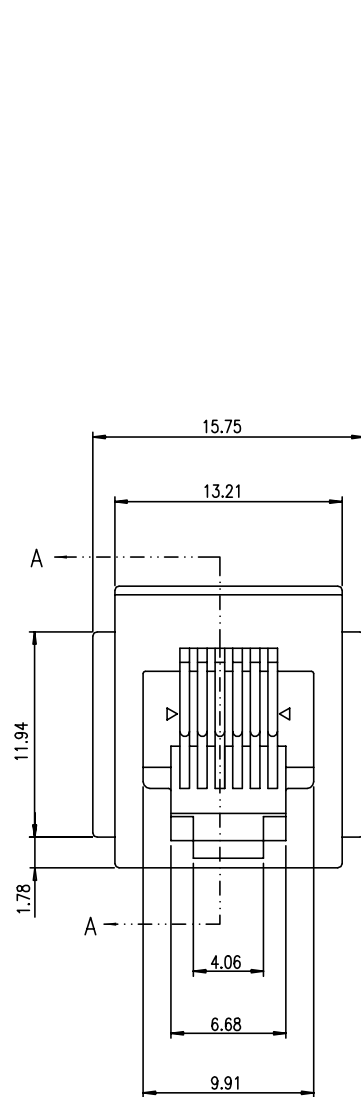
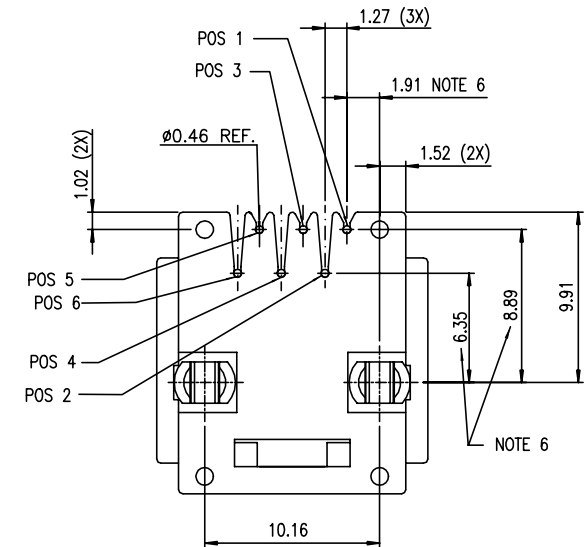


PRODUCT NO.

SEE TABLE



SECTION A-A



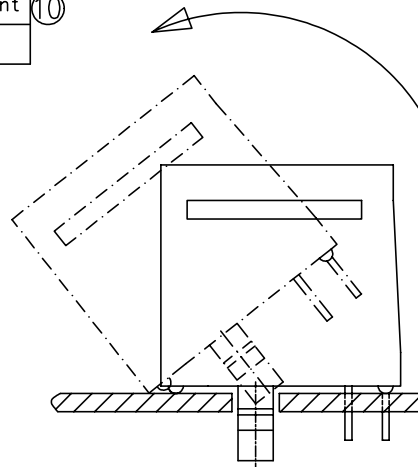
mat'l. code				surface		tolerance		projection		product family						
				ISO1302 ✓		ISO1101 ISO406				MOD JACK						
ltn		ecn	nodr	date		tolerances unless otherwise specified				title						
E	N04-0125		YS	12/08/04		angle		0.X±0.3				6 POS VERT. SPECIAL PEG				
F	N05-0099		IS	04/01/05				0.XX±0.15								
G	N08-0097		SH	09/24/08		0°±2'		0.XXX±0.05		scale 2.0				P.C.B. III MOD JACK ASSY		
H	N08-0170		SH	10/08/08		dr	C L FENG		02/21/97		dwg no		sheet 1 of 2	size		
J	ELX-N-011054		SH	MMO	03/14/12		engr	TONY CHIEN		02/21/97				61837		A4
						chr	TONY CHIEN		02/21/97							
						appd	JENN TSAO		02/21/97							
sheet		revision		J	J											
index		sheet		1	2											

PRODUCT NO.	POSITIONS LOADED	HOUSING P/N	HSG COLOR
61837-X661	ALL	61836-001	BLACK
-X661LF		61836-011	BLACK
-X661HLF			
-X641	2,3,4,5	61836-001	BLACK
-X641LF		61836-011	BLACK
-X641HLF			
-X621	3,4	61836-001	BLACK
-X621LF		61836-011	BLACK
-X621HLF			
-X662	ALL	61836-002	GREY
-X662LF		61836-012	GREY
-X662HLF			
-X642	2,3,4,5	61836-002	GREY
-X642LF		61836-012	GREY
-X642HLF			
-X622	3,4	61836-002	GREY
-X622LF		61836-012	GREY
-X622HLF			
-X612LF	1,6	61836-002	GREY
-X612HLF		61836-012	GREY

LEAD FREE PRODUCT NO.
MEETS PIP PROCESS PRODUCT NO.

PLATING CODE X	PLATING
0	5u" Au + high performance lubricant
1	15 u"/.38 uM GOLD
3	5u" Au + high performance lubricant
5	50u"/1.27 uM GOLD

DIRECTION OF DISMOUNT

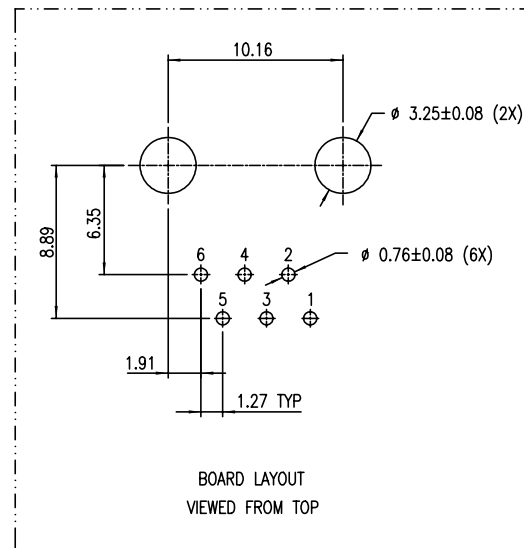


JACK DISMOUNT METHOD

 DETAIL A
NOTE 5

NOTES :

- 1 P/N WITH DASH X6XX -NORMAL WAVE SOLDERING APPLICATION.
- 2 PACKAGING SPEC. GES-14-351 (USING TRAY).
- ③ SCRATCH MARKS ACCEPTABLE ON THESE SURFACES.
- 4 JACK IS FOR 1.57/.062 THICK PCB.
- ⑤ SHOULD THE JACK NEED TO BE DISMOUNTED FROM THE PCB. PLS REMOVE JACK AS PER RECOMMENDED METHOD HEREIN. (DETAIL A) NIPPING THE LEGS OF THE PEG TOGETHER IS DISALLOWED, OTHERWISE LEG BREAKAGE MAY OCCUR.
- ⑥ THESE DIMENSIONS ARE MEASURED FROM THE TOP OF THE PEG.
- 7 THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- 8 IF LF P/N PACKSGING MEETS GS-14-920 SPECIFICATION
- 9 THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57mm MINIMUM THICK CIRCUIT BOARD
- ⑩ EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOEMR .



part code	surface	tolerance	projection	product family
ISO1302	ISO1101 ISO406			MOD JACK
tolerances unless otherwise specified				
angle	0.X±0.3		mm	6 POS VERT. SPECIAL PEG
0°±2'	0.XX±0.15		scale 2.0	P.C.B. III MOD JACK ASSY
0°±2'	0.XXX±0.05			
dr	c L FENG	02/21/97		dwg no
engr	TONY CHIEN	02/21/97		sheet 2 of 2
chr	TONY CHIEN	02/21/97		size
appd	JENN TSAO	02/21/97		61837 A4
sheet index	revision sheet			type Product Customer Drawing

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[FCI / Amphenol:](#)

[61837-0621LF](#) [61837-0612LF](#) [61837-0641](#) [61837-0641LF](#) [61837-5641](#) [61837-5641LF](#) [61837-0621](#) [61837-0661LF](#)
[61837-1661LF](#)